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# FSDM0465RE, FSDM0565RE, FSDM07652RE Green Mode Power Switch

#### **Features**

- Internal Avalanche-Rugged SenseFET
- Advanced Burst-Mode Operation Consumes Under 1W at 240V<sub>AC</sub> & 0.5W load
- Precision Fixed Operating Frequency (66kHz)
- Internal Start-up Circuit
- Improved Pulse-by-Pulse Current Limiting
- Over-Voltage Protection (OVP)
- Overload Protection (OLP)
- Internal Thermal Shutdown Function (TSD)
- Auto-Restart Mode
- Under-Voltage Lockout (UVLO) with hysteresis
- Low Operating Current (2.5mA)
- Built-in Soft-Start

# **Applications**

- SMPS for LCD monitor and STB
- Adaptor

### **Description**

The FSDM0465RE, FSDM0565RE and FSDM07652RE are an integrated Pulse Width Modulator (PWM) and SenseFET specifically designed for high-performance offline Switch Mode Power Supplies (SMPS) with minimal external components. This device is an integrated high-voltage power-switching regulator that combines an avalanche-runged SenseFET with a current mode PWM control block. The PWM controller includes an integrated fixed-frequency oscillator, undervoltage lockout, leading-edge blanking (LEB), optimized gate driver, internal soft-start, temperature-compensated precise-current sources for a loop compensation, and self protection circuitry. Compared with a discrete MOSFET and PWM controller solution, it can reduce total cost; component count, size, and weight; while simultaneously increasing efficiency, productivity, and system reliability. This device is a basic platform well suited for cost-effective designs of flyback converters.

# Ordering Information

| Product Number                | Package              | Marking Code | BV <sub>DSS</sub> | R <sub>DS(ON)</sub> Max. |
|-------------------------------|----------------------|--------------|-------------------|--------------------------|
| FSDM0465REWDTU <sup>(1)</sup> | TO-220F-6L (Forming) | DM0465RE     | 650V              | 2.6 Ω                    |
| FSDM0565REWDTU                | TO-220F-6L (Forming) | DM0565RE     | 650V              | 2.2 Ω                    |
| FSDM07652REWDTU               | TO-220F-6L (Forming) | DM07652RE    | 650V              | 1.6 Ω                    |

#### Note:

1. WDTU: Forming Type.



All packages are lead free per JEDEC: J-STD-020B standard.

# **Typical Circuit**

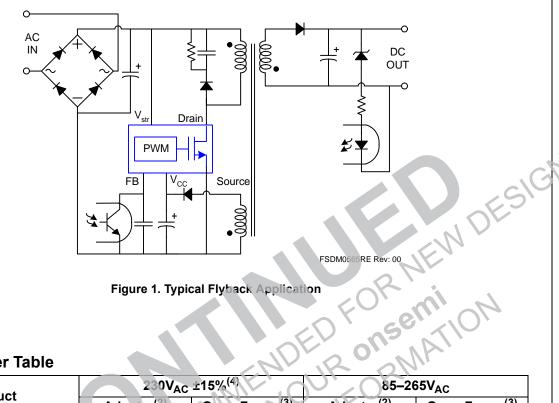


Figure 1. Typical Flyback Application

# **Output Power Table**

| Product     | 230V <sub>AC</sub>     | ±15% <sup>(4)</sup> | 85–265V <sub>AC</sub>  |                           |  |
|-------------|------------------------|---------------------|------------------------|---------------------------|--|
| Product     | Adapter <sup>(2)</sup> | Open Frame (3)      | Adapter <sup>(2)</sup> | Open Frame <sup>(3)</sup> |  |
| FSDM0465RE  | 48W                    | 56W                 | 40W                    | 48W                       |  |
| FSDM0565RE  | 60W                    | 70W                 | 50W                    | 60W                       |  |
| FSDM07652RE | 70W                    | SOW                 | 60W                    | 70W                       |  |

#### Notes:

- 2. Typical continuous power in a non-ventilated enclosed adapter measured at 50°C ambient.
- 3. Maximum practical continuous power in an open-frame design at 50°C ambient.
- 4. 230V  $_{AC}$  or 100/115V  $_{AC}$  with doubler.

# **Internal Block Diagram**

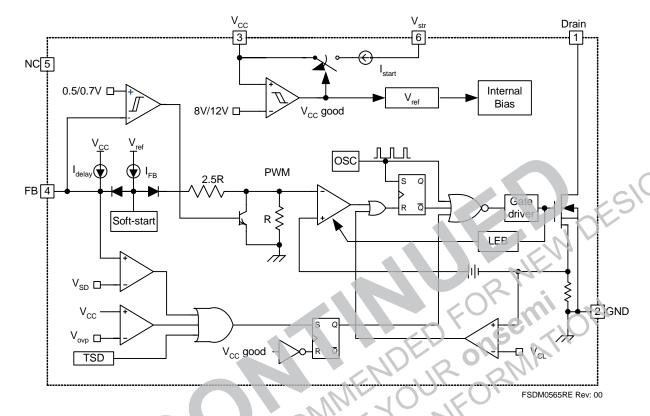


Figure 2. Functional Block Diagram of FSDM0:65RE

# **Pin Configuration**

#### TO-220F-6L

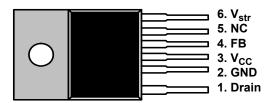


Figure 3. Pin Configuration (Top View)

### **Pin Definitions**

| Pin # Name |                  | Description  |
|------------|------------------|--|
| 1 Drain    |                  | <b>SenseFET drain.</b> This pin is the high-voltage power SenseFET drain. It is designed to drive the transformer directly.  |
| 2          | GND              | Ground. This pin is the control ground and the Sensef £1 source  |
| 3          | V <sub>CC</sub>  | <b>Power Supply.</b> This pin is the positive supply voltage input. During start-up, the power is supplied by an internal high-voltage current source connected to the V <sub>str</sub> pin. When V <sub>CC</sub> reaches 12V, the internal high-voltage current source is disabled and the power is supplied from the auxiliary transformer winding.            |
| 4          | FB               | Fee back. This pin is internally connected to the inverting input of the PWM comparator. The collector of an opto-coupler is typically tied to this pin. For stable operation, a capacitor should be placed between this pin and GND. If the voltage of this pin reaches 6.0V, the overload protection is activated, re-suiting in shutdown of the Power Switch. |
| 5          | NC               | No Connection.   |
| 6          | V <sub>str</sub> | <b>Start-up.</b> This pin is connected directly to the high-voltage DC link. At start-up, the internal high voltage current source supplies internal bias and charges the external capacitor connected to the V <sub>CC</sub> pin. Once V <sub>CC</sub> reaches 12V, the internal current source is disabled.  |

## **Absolute Maximum Ratings**

The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings.  $T_A = 25^{\circ}C$ , unless otherwise specified.

| Symbol                    | Parameter   |                                 |                       | Value   | Unit            |  |
|---------------------------|---|---------------------------------|-----------------------|---|-----------------|--|
| BV <sub>DSS</sub>         | Drain Source Breakdown  | Voltage                         |                       | 650   | V               |  |
| V <sub>str</sub>          | Max. Voltage at Vstart pin  |                                 |                       | 650   | V               |  |
|                           |   | FSDM0465RE T <sub>C</sub> =25°C |                       | 9.6   |                 |  |
| I <sub>DM</sub>           | Drain Current Pulsed <sup>(5)</sup>   | FSDM0565RE                      | T <sub>C</sub> =25°C  | 11  | A <sub>DC</sub> |  |
|                           |   | FSDM07652RE                     | T <sub>C</sub> =25°C  | 15  |                 |  |
|                           |   | FSDM0465RE                      | T <sub>C</sub> =25°C  | 2.2   |                 |  |
|                           |   | F3DIVIO403RE                    | T <sub>C</sub> =100°C | 1.4   | .6              |  |
| ,                         | Continuous Drain Current  | ESDMOESEDE                      | T <sub>C</sub> =25°C  | 2.8   |                 |  |
| I <sub>D</sub>            | Continuous Drain Current  | FSDIVIOSOSKE                    | T <sub>C</sub> =100°C | 1.7   | A               |  |
|                           | FSDM07652RE   |                                 | T <sub>C</sub> =25°C  | 3.8   | 110             |  |
|                           |   | F3DIVIO7032RE                   | T <sub>C</sub> =100°C | 2.4   |                 |  |
|                           | FSDM0465RE  |                                 | FSDM0465RE            |   |                 |  |
| E <sub>AS</sub>           | Single Pulsed Avalanche Energy <sup>(6)</sup> FSDM0565RE FSDM07652RE        |                                 |                       | 190   | nij             |  |
|                           |   |                                 |                       | 370   | (10)            |  |
| V <sub>CC</sub>           | Supply Voltage  |                                 | 10,                   | 20  | V               |  |
| $V_{FB}$                  | Input Voltage Range   |                                 | CH.                   | -0.3 to $V_{CC}$  | V               |  |
| P <sub>D</sub> (Watt H/S) | Total Power Dissipation (T  | c=25°C)                         |                       | 45  | W               |  |
| $T_J$                     | Operating Junction Temperature  |                                 |                       | Internally limited  | °C              |  |
| $T_A$                     | Operating Ambient Temperature   |                                 |                       | -25 to +85  | °C              |  |
| T <sub>STG</sub>          | Storage Temperature   |                                 |                       | -55 to +150   | °C              |  |
|                           | ESD Capability, HBM Model<br>(All pins except V <sub>str</sub> and FB)      |                                 |                       | $\begin{array}{c} 2.0\\ (\text{GND-V}_{\text{str}}/\text{V}_{\text{FB}}\text{=}1.5\text{kV}) \end{array}$ | kV              |  |
|                           | ESD Capability, Machine Model<br>(All pins except V <sub>str</sub> and r-B) |                                 |                       | 300  (GND-Vstr/VFB=225V)  | V               |  |

#### Notes

- 5. Repetitive rating: Pulse width limited by maximum junction temperature.
- 6. L=14mH, starting T<sub>J</sub>=25°C.

# Thermal Impedance

T<sub>A</sub>=25°C, unless otherwise specified.

| Symbol              | Parameter                              | Value | Unit |
|---------------------|--|-------|------|
| $\theta_{JA}^{(7)}$ | Junction-to-Ambient Thermal Resistance | 49.90 | °C/W |
| θ <sub>JC</sub> (8) | Junction-to-Case Thermal Resistance    | 2.78  | °C/W |

#### Notes:

- 7. Free-standing, with no heat-sink, under natural convection.
- 8. Infinite cooling condition refer to the SEMI G30-88.

# **Electrical Characteristics**

 $T_A = 25^{\circ}C$  unless otherwise specified.

| Symbol               | Parame   | ter                       | Condition  | Min. | Тур. | Max. | Unit |  |
|----------------------|--|---------------------------|--|------|------|------|------|--|
| SenseFET             | SECTION  |                           |  |      | •    | •    |      |  |
|                      |  | ESDM0465DE                | V <sub>DS</sub> = 650V, V <sub>GS</sub> = 0V                         |      |      | 250  |      |  |
|                      |  | FSDM0465RE                | V <sub>DS</sub> = 520V, V <sub>GS</sub> = 0V, T <sub>C</sub> = 125°C |      |      | 250  |      |  |
|                      | Zero Gate Voltage                                | COMORGEDE                 | V <sub>DS</sub> = 650V, V <sub>GS</sub> = 0V                         |      |      | 500  |      |  |
| I <sub>DSS</sub>     | Drain Current                                    | FSDM0565RE                | V <sub>DS</sub> = 520V, V <sub>GS</sub> = 0V, T <sub>C</sub> = 125°C |      |      | 500  | μA   |  |
|                      |  | FSDM07652RE               | V <sub>DS</sub> = 650V, V <sub>GS</sub> = 0V                         |      |      | 500  |      |  |
|                      |  | F3DIVIO7632RE             | V <sub>DS</sub> = 520V, V <sub>GS</sub> = 0V, T <sub>C</sub> = 125°C |      |      | 500  |      |  |
|                      | 0  | FSDM0465RE                |  |      | 2.20 | 2.60 |      |  |
| R <sub>DS(ON)</sub>  | Static Drain Source on Resistance <sup>(9)</sup> | FSDM0565RE                | $V_{GS} = 10V, I_D = 2.5A$   |      | 1.76 | 2.20 | Ω    |  |
|                      | on resistance                                    | FSDM07652RE               |  |      | 1.40 | 1.60 |      |  |
|                      |  | FSDM0465RE                |  |      | 60   | 4    |      |  |
| Coss                 | Output Capacitance                               | FSDM0565RE                | $V_{GS} = 0V, V_{DS} = 25V, f = 1MHz$                                |      | 78   |      | pF   |  |
|                      |  | FSDM07652RE               |  | 2    | 100  |      |      |  |
|                      |  | FSDM0465RE                | 20   |      | 23   | 10   | 7    |  |
| t <sub>d(on)</sub>   | Turn-On Delay Time                               | FSDM0565RE                | V <sub>DD</sub> = 325 ∨, I <sub>D</sub> = 5A                         | 50   | 22   | O.   | ns   |  |
|                      |  | FSDM07652RE               | OF OF  | 1    | 22   |      |      |  |
|                      |  | FSDM0465RE                | IN IR  | 011  | 20   |      |      |  |
| t <sub>r</sub>       | Rise Time  | FSDM0565RE                | $V_{DD} = 325 V, I_{D} = 5A$   |      | 52   |      | ns   |  |
|                      |  | FSDN 07652RE              | MILLACINE  |      | 60   |      |      |  |
|                      |  | FSDM0465RE                | 0, 0, 0  |      | 65   |      |      |  |
| $t_{d(off)}$         | Turn-Off Delay Time                              | FSDM0565RE                | $V_{DD} = 325V, I_D = \xi A$   |      | 95   |      | ns   |  |
|                      |  | FSDM07652RE               | 71.56  |      | 115  |      |      |  |
|                      |  | FSDM0465PE                |  |      | 27   |      |      |  |
| ίf                   | Fall Time  | FSDM0565RE                | $V_{DD} = 325V, I_D = 5A$  |      | 50   |      | ns   |  |
|                      | 13.1   | FSDM07652PE               |  |      | 65   |      |      |  |
| CONTROL              | SECTION  |                           |  |      |      |      |      |  |
| fosc                 | Switching Frequency                              | 25                        | V <sub>FB</sub> = 3V   | 60   | 66   | 72   | kHz  |  |
| Δf <sub>STABLE</sub> | Switching Frequency S                            | Stability                 | $13V \le V_{CC} \le 18V$   | 0    | 1    | 3    | %    |  |
| $\Delta f_{OSC}$     | Switching Frequency \                            | /ariation <sup>(10)</sup> | $-25^{\circ}C \le T_A \le 85^{\circ}C$                               | 0    | ±5   | ±10  | %    |  |
| I <sub>FB</sub>      | Feedback Source Cur                              | rent                      | V <sub>FB</sub> = GND  | 0.7  | 0.9  | 1.1  | mA   |  |
|                      |  | FSDM0465RE                |  | 77   | 82   | 87   | %    |  |
| $D_{MAX}$            | Maximum Duty Cycle                               | FSDM0565RE                |  | 77   | 82   | 87   | %    |  |
|                      |  | FSDM07652RE               |  | 75   | 80   | 85   | %    |  |
| D <sub>MIN</sub>     | Minimum Duty Cycle                               |                           |  |      |      | 0    | %    |  |
| V <sub>START</sub>   | UVLO Threshold Volta                             | 200                       | V <sub>FB</sub> = GND  | 11   | 12   | 13   | V    |  |
| V <sub>STOP</sub>    | TOVEO THIESHOID VOITE                            | ıy <del>c</del>           | V <sub>FB</sub> = GND  | 7    | 8    | 9    | V    |  |
| t <sub>S/S</sub>     | Internal Soft-Start Tim                          | е                         | V <sub>FB</sub> = 3  |      | 10   | 15   | ms   |  |
|                      |  |                           | •  |      |      |      |      |  |

### **Electrical Characteristics** (Continued)

 $T_A = 25$ °C unless otherwise specified.

| Symbol               | Paramete                           | Parameter               |  | Min. | Тур. | Max. | Unit  |  |  |
|----------------------|------------------------------------|-------------------------|--|------|------|------|-------|--|--|
| BURST MO             | BURST MODE SECTION                 |                         |  |      |      |      |       |  |  |
| V <sub>BURH</sub>    | Buret Mode Voltages                |                         | V <sub>CC</sub> = 14V                        |      | 0.7  |      | V     |  |  |
| V <sub>BURL</sub>    | Burst Mode Voltages                |                         | V <sub>CC</sub> = 14V                        |      | 0.5  |      | V     |  |  |
| PROTECT              | ION SECTION                        |                         |  | •    | •    |      |       |  |  |
| V <sub>SD</sub>      | Shutdown Feedback Volt             | age                     | $V_{FB} \ge 5.5 V$                           | 5.5  | 6.0  | 6.5  | V     |  |  |
| I <sub>DELAY</sub>   | Shutdown Delay Current             |                         | V <sub>FB</sub> = 5V                         | 2.8  | 3.5  | 4.2  | μΑ    |  |  |
| t <sub>LEB</sub>     | Leading-Edge Blanking T            | ime                     |  |      | 250  |      | ns    |  |  |
|                      |                                    | FSDM0465RE              | V <sub>FB</sub> = 5V, V <sub>CC</sub> = 14V  | 1.60 | 1.80 | 2.00 | . (2) |  |  |
| I <sub>LIMIT</sub>   | Peak Current Limit <sup>(11)</sup> | FSDM0565RE              | V <sub>FB</sub> = 5V, V <sub>CC</sub> = 14V  | 2.00 | 2.25 | 2.50 | Α     |  |  |
|                      |                                    | FSDM07652RE             | V <sub>FB</sub> = 5V, V <sub>CC</sub> = 14V  | 2.20 | 2.50 | 2.70 |       |  |  |
| V <sub>OVP</sub>     | Over-Voltage Protection            |                         |  | 18   | 19   | 20   | V     |  |  |
| T <sub>SD</sub>      | Thermal Shutdown Temp              | erature <sup>(10)</sup> |  | 130  | 145  | 160  | °C    |  |  |
| TOTAL DEVICE SECTION |                                    |                         |  |      |      |      |       |  |  |
| I <sub>OP</sub>      |                                    |                         | V <sub>FB</sub> = GND, V <sub>CC</sub> = 14V |      |      | 10   | 4     |  |  |
| I <sub>OP(MIN)</sub> | Operating Supply Curren            | t <sup>(12)</sup>       | $V_{FB} = GND, V_{CC} = 10V$                 | 150  | 2.5  | 5.0  | mA    |  |  |
| I <sub>OP(MAX)</sub> |                                    |                         | $V_{FB} = GND, V_{CC} = 18V$                 |      |      | *    |       |  |  |

#### Notes:

- 9. Pulse test: Pulse width  $\leq 300 \mu S$ , duty cycle  $\leq 2\%$ .
- ...e control IC. 10. These parameters, although guaranteed at the design, are not tested in production.

### Comparison Between FS6M0765RTC and FSDM0x65RE

| Function             | FS6M0765RTC   | FSDM0x65RE                                      | FSDM0x65RE Advantages  |
|----------------------|---|---|--|
| Soft-Start           | Adjustable soft-start time using an external capacitor                                  | Internal soft-start with typically 10ms (fixed) | <ul> <li>Gradually increasing current limit during soft-start reduces peak current and voltage component stresses</li> <li>Eliminates external soft-start components in most applications</li> <li>Reduces or eliminates output overshoot</li> </ul> |
| Burst-Mode Operation | <ul><li>Built into controller</li><li>Output voltage<br/>drops to around half</li></ul> |   | ■ Improves light-load efficiency ■ Reduces no-load consumption   |

# **Typical Performance Characteristics**

These characteristic graphs are normalized at  $T_A$ = 25°C.

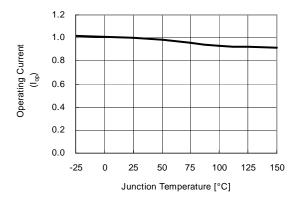


Figure 4. Operating Current vs. Temp.

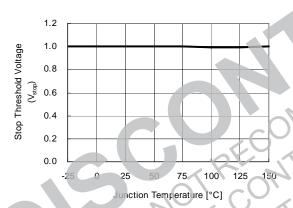


Figure 5. Start Threshold Voltage vs. Temp.

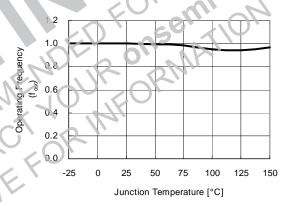


Figure 6. Stop Threshold Voltage vs. Temp.

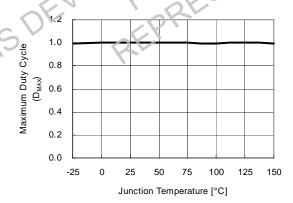


Figure 7. Operating Frequency vs. Temp.

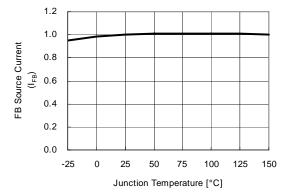
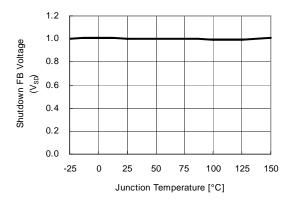


Figure 8. Maximum Duty Cycle vs. Temp.

Figure 9. Feedback Source Current vs. Temp.

# **Typical Performance Characteristics** (Continued)

These characteristic graphs are normalized at  $T_A$ = 25°C.



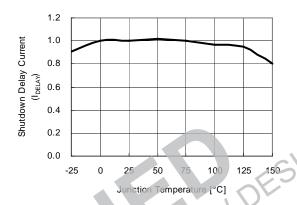
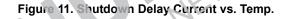
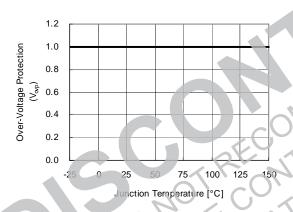


Figure 10. Shutdown Feedback Voltage vs. Temp.





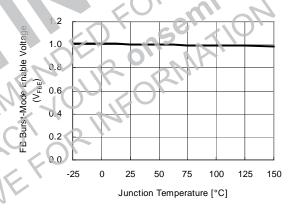
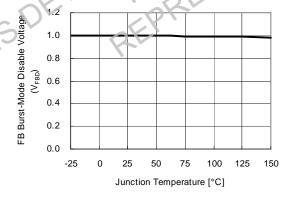


Figure 12. Over Voltage Protection vs. Temp.

Figure 13. Burst-Mode Enable Voltage vs. Temp.



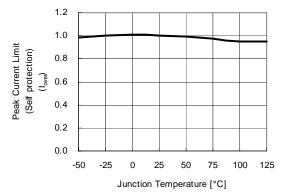


Figure 14. Burst-Mode Disable Voltage vs. Temp.

Figure 15. Current Limit vs. Temp.

# **Typical Performance Characteristics** (Continued)

These characteristic graphs are normalized at  $T_A$ = 25°C.

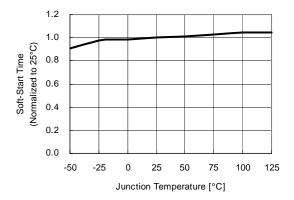
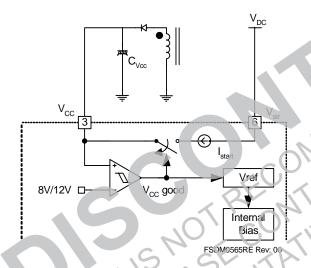


Figure 16. Soft-Start Time vs. Temp.

### **Functional Description**

of 1. Start-up: In previous generations Power Switches the V<sub>CC</sub> pin had an external startup resistor to the DC input voltage line. In this generation, the start-up resistor is replaced by an internal high-voltage current source. At start-up, the internal high-voltage current source supplies the internal bias and charges the external capacitor  $(C_{vcc})$  connected to the  $V_{CC}$  pin, as illustrated in Figure 17. When V<sub>CC</sub> reaches 12V, the FSDM0x65RE begins switching and the internal highcurrent source disabled. is FSDM0x65RE continues normal switching operation and the power is supplied from the auxiliary transformer winding unless V<sub>CC</sub> goes below the stop voltage of 8V.



igure 17. Internal Start up Circuit

2. Feedback Control: FSDM.0x65RE employs current-mode control, as shown in Figure 18. An opto-coupler (such as the H11A817A) and shunt regulator (such as the KA431) are typically used to implement the feedback network. Comparing the feedback voltage with the voltage across the R<sub>sense</sub> resistor, plus an offset voltage, makes it possible to control the switching duty cycle. When the reference pin voltage of the shunt regulator exceeds the internal reference voltage of 2.5V, the opto-coupler LED current increases, pulling down the feedback voltage and reducing the duty cycle. This event typically occurs when the input voltage is increased or the output load is decreased.

- **2.1 Pulse-by-Pulse Current Limit**: Because current-mode control is employed, the peak current through the SenseFET is limited by the inverting input of PWM comparator ( $V_{FB}^*$ ) as shown in Figure 18. Assuming that the 0.9mA current source flows only through the internal resistor (2.5R + R = 2.8k $\Omega$ ), the cathode voltage of diode D2 is about 2.5V. Since D1 is blocked when the feedback voltage ( $V_{FB}$ ) exceeds 2.5V, the maximum voltage of the cathode of D2 is clamped at this voltage, thus clamping  $V_{FB}^*$ . Therefore, the peak value of the current through the SenseFET is limited.
- **2.2 Leading Edge Blanking (LEB)**: At the instant the internal SenseFET is turned on a high-current spike occurs through the SenseFET, caused by primary-side capacitance and secondary-side rectifier reverse recovery. Excessive voltage across the  $R_{\text{sense}}$  resistor would lead to incorrect feedback operation in the current mode PWM control. To counter this effect, the FSDM0x65RE employs a leading-edge blanking (LEB) circuit. This circuit inhibits the PWM comparator for a short time ( $t_{\text{LEB}}$ ) after the SenseFET is turned on.

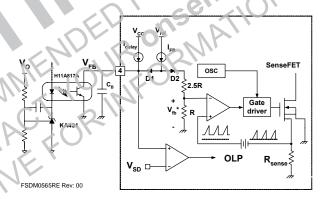


Figure 18. Pulse-Width-Modulation (PWM) Circuit

3. Protection Circuit: The FSDM0x65RE has several self-protective functions, such as overload protection (OLP), over-voltage protection (OVP), and thermal shutdown (TSD). Because these protection circuits are fully integrated into the IC without external components, the reliability is improved without increasing cost. Once a fault condition occurs, switching is terminated and the SenseFET remains off, which causes  $V_{\mbox{\footnotesize CC}}$  to fall. When V<sub>CC</sub> reaches the UVLO stop voltage of 8V, the protection is reset and the internal high-voltage current source charges the V<sub>CC</sub> capacitor via the V<sub>str</sub> pin. When V<sub>CC</sub> reaches the UVLO start voltage of 12V, the FSDM0x65RE resumes normal operation. In this manner, the auto-restart can alternately enable and disable the switching of the power SenseFET until the fault condition is eliminated (see Figure 19).

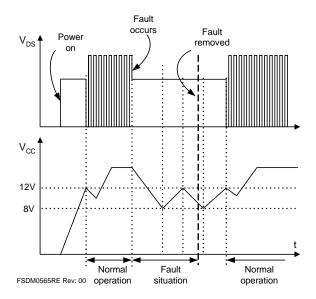


Figure 19. Auto Restart Operation

3.1 Overload Protection (OLP): Overload is defined as the load current exceeding a pre-set level due to an unexpected event. In this situation, the protection circuit should be activated to protect the SMPS. Even when the SMPS is in normal operation, the overload protection circuit can be activated during the load transition. To avoid this undesired operation, the overload protection circuit is designed to be activated after a specified time to determine whether it is a transient situation or a true overload situation. Because of the pulse-by-pulse current limit capability, the maximum peak current through the SenseFET is limited, and therefore the maximum input power is restricted with a given input voltage. If the output consumes beyond this maximum power, the output voltage (V<sub>O</sub>) decreases below the set voltage. This reduces the current through the optocoupler LED, which also reduces the opto-coupler transistor current, thus increasing the feedback voltage  $(V_{FB})$ . if  $V_{FB}$  exceeds 2.5 \( \text{D1} \) is blocked and the 3.5 \( \mu A \) current source starts to charge C<sub>B</sub> slowly up to V<sub>CC</sub>. In this condition, V<sub>FB</sub> continues increasing until it reaches 6V, when the switching operation is terminated, as shown in Figure 20. The delay time for shutdown is the time required to charge C<sub>B</sub> from 2.5V to 6.0V with 3.5µA. A 10 ~ 50ms delay time is typical for most applications.

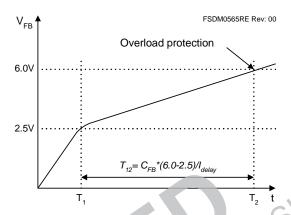


Figure 20. Overload Protection

- 3.2 Over-Voltage Protection (OVP): If the secondary side feedback circuit were to malfunction or a solder defect caused an opening in the feedback path, the current through the opto-coupler transistor becomes almost zero. In this event, V<sub>FB</sub> climbs in a similar manner to the overload situation, forcing the preset maximum current to be supplied to the SMPS until the overload protection is activated. Because more energy than required is provided to the output, the output voltage may exceed the rated voltage before the overload protection is activated, resulting in the breakdown of the devices in the secondary side. To prevent this situation, an overvoltage protection (OVP) circuit is employed. In general, V<sub>CC</sub> is proportional to the output voltage and the FSDM0x65RE uses V<sub>CC</sub> instead of directly monitoring the output voltage. If V<sub>CC</sub> exceeds 19V, an OVP circuit is activated, resulting in the termination of the switching operation. To avoid undesired activation of OVP during normal operation, V<sub>CC</sub> should be designed below 19V.
- **3.3 Thermal Shutdown (TSD)**: The SenseFET and the control IC are built in one package. This makes it easy for the control IC to detect the heat generation from the SenseFET. When the temperature exceeds ~150°C, the thermal shutdown is activated.
- 4. Soft-Start: The FSDM0x65RE has an internal soft-start circuit that increases PWM comparator inverting input voltage, together with the SenseFET current, slowly after it starts up. The typical soft-start time is 10ms. The pulse width to the power switching device is progressively increased to establish the correct working conditions for transformers, inductors, and capacitors. The voltage on the output capacitors is progressively increased with the intention of smoothly establishing the required output voltage. It also helps prevent transformer saturation and reduces the stress on the secondary diode during start-up.

**5. Burst Operation**: To minimize power dissipation in standby mode, the FSDM0x65RE enters burst-mode operation. As the load decreases, the feedback voltage decreases. As shown in Figure 21, the device automatically enters burst mode when the feedback voltage drops below  $V_{BURL}(500\text{mV})$ . At this point, switching stops and the output voltages start to drop at a rate dependent on standby current load. This causes the feedback voltage to rise. Once it passes  $V_{BURH}(700\text{mV})$ , switching resumes. The feedback voltage then falls and the process repeats. Burst-mode operation alternately enables and disables switching of the power SenseFET, thereby reducing switching loss in standby mode.

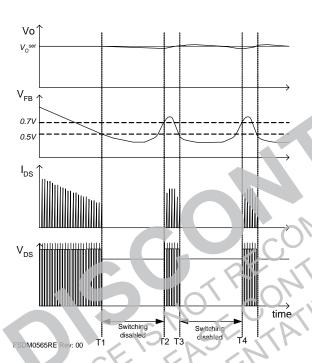


Figure 21. Waveforms of Burst Operation

## **Application Information**

| Application | Output Power | Input Voltage                               | Output Voltage (Max. Current) |
|-------------|--------------|---|-------------------------------|
| LCD Monitor | 40W          | Universal input<br>(85-265V <sub>AC</sub> ) | 5V (2.0A)<br>12V (2.5A)       |

#### **Features**

- High efficiency (>81% at 85V<sub>AC</sub> input)
- Low zero load power consumption (<300mW at 240V<sub>AC</sub> input)
- Low standby mode power consumption (<800mW at 240V<sub>AC</sub> input and 0.3W load)
- Low component count
- Enhanced system reliability through various protection functions
- Internal soft-start (10ms)

#### **Key Design Notes**

- Resistors R102 and R105 are employed to prevent start-up at low input voltage. After start-up, there is no power loss in these resistors since the start-up pin is internally disconnected after start-up.
- The delay time for overload protection is designed to be about 50ms with C106 of 47nF. If a faster triggering of OLP is required, C106 can be reduced to 10nF.
- Zener diode ZD102 is used for a safety test, such as UL. When the drain pin and feedback pin are shorted, the zener diode fails and remains short, which causes the fuse (F1) to be blown and prevents explosion of the opto-coupler (IC301). This zener diode also increases the immunity against line surge.

#### 1. Schematic

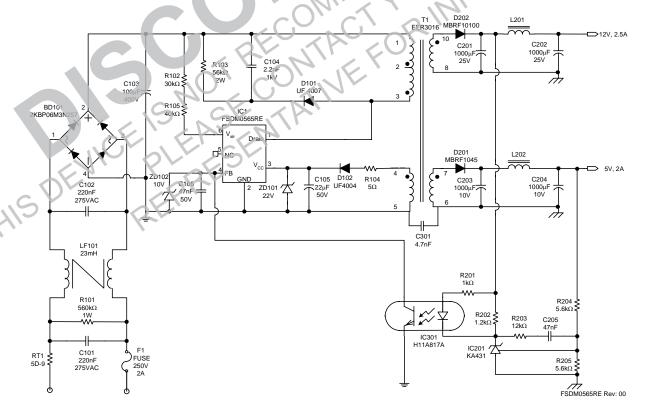


Figure 22. Demo Circuit

#### 2. Transformer

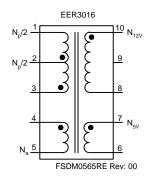


Figure 23. Transformer Schematic Diagram

### 3. Winding Specification

| No   | Pin (s→f)  | Wire                   | Turns | Winding Method   |  |  |  |  |
|--|--|------------------------|-------|------------------|--|--|--|--|
| N <sub>a</sub>                                   | 4 → 5  | 0.2 <sup>♦</sup> × 1   | 8     | Canter Winding   |  |  |  |  |
| Insulation: Polyester Tape t = 0.050mm, 2 Layers |  |                        |       |                  |  |  |  |  |
| N <sub>p</sub> /2                                | 2 → 1  | $0.4^{\circ} \times 1$ | 18    | Solenoid Winding |  |  |  |  |
| Insulation:                                      | Insulation: Polyester Tape t = 0.050mm, 2 Layers       |                        |       |                  |  |  |  |  |
| N <sub>12V</sub>                                 | 10 → 8   | $0.3^{\phi} \times 3$  | 7     | Center Winding   |  |  |  |  |
| Insulation:                                      | Polyester Tape $t = 0.050$                             | mm, 2 Layers           | C, 28 |                  |  |  |  |  |
| N <sub>5V</sub>                                  | 7 → 6  | $0.3^{\circ} \times 3$ | 3     | Center Winding   |  |  |  |  |
| Insulation: Polyester Tape t = 0.050mm, 2 Layers |  |                        |       |                  |  |  |  |  |
| N <sub>p</sub> /2                                | 3 -> 2   | 0.4 <sup>φ</sup> × 1   | 18    | Solenoid Winding |  |  |  |  |
| Outer Insul                                      | Outer insulation: Polyester Tape t = 0.050mm, 2 Layers |                        |       |                  |  |  |  |  |

# 4. Electrical Characteristics

|                    | Pin   | Specification | Remarks                   |
|--------------------|-------|---------------|---------------------------|
| Inductance         | 1 - 3 | 520μH ± 10%   | 100kHz, 1V                |
| Leakage Inductance | 1 - 3 | 10μH Max      | 2 <sup>nd</sup> all short |

#### 5. Core & Bobbin

Core: EER 3016Bobbin: EER3016Ae(mm2): 96

### 6. Demo Circuit Part List

| Part  | Value                    | Note                   | Part                  | Value                      | Note                    |
|-------|--------------------------|------------------------|-----------------------|----------------------------|-------------------------|
|       | Fus                      | se                     | D102                  | UF4004                     |                         |
| F101  | 2A/250V                  |                        | D201                  | MBRF1045                   |                         |
|       |                          |                        | D202                  | MBRF10100                  |                         |
|       | NT                       | C                      | ZD101 Zener Diode 22V |                            |                         |
| RT101 | 5D-9                     |                        | ZD102                 | Zener Diode                | 10V                     |
|       |                          |                        |                       |                            |                         |
|       | Resi                     | stor                   |                       | Bridge                     | Diode                   |
| R101  | 560kΩ                    | 1W                     | BD101                 | 2KBP06M 3N257              | Bridge Diode            |
| R102  | 30kΩ                     | 1/4W                   |                       |                            | (5)                     |
| R103  | 56kΩ                     | 2W                     |                       | Line I                     | ilter                   |
| R104  | 5Ω                       | 1/4W                   | LF101                 | 23mH                       | Wire 0.4mm              |
| R105  | 40kΩ                     | 1/4W                   |                       |                            |                         |
| R201  | 1kΩ                      | 1/4W                   |                       | IC                         | 2                       |
| R202  | 1.2kΩ                    | 1/4W                   | IC101                 | FSDM0565RE                 | Power S witch (5A,650V) |
| R203  | 12kΩ                     | 1/4W                   | IC201                 | KA431 (TL431)              | Voltage reference       |
| R204  | 5.6k $Ω$                 | 1/4W                   | lC301                 | H11A817A                   | Opto-coupler            |
| R205  | 5.6kΩ                    | 1/4W                   |                       | ND 12                      |                         |
|       |                          |                        | ANE.                  | HIIABITA<br>NOUR<br>NORINE |                         |
|       | Сара                     | citor                  | VIA.                  | 10 76                      |                         |
| C101  | 220nF/275V <sub>AC</sub> | Box Capacitor          | (1)                   | 0                          |                         |
| C102  | 220nF/275V <sub>AC</sub> | Box Capacitor          | DO                    | OK                         |                         |
| C103  | 100µF/400V               | Electrolytic Capacitor | 1, 1                  |                            |                         |
| C104  | 2.2nF/1kV                | Ceramic Capacitor      |                       | *                          |                         |
| C105  | 22µF/50V                 | Electrolytic Capacitor | 12                    |                            |                         |
| C106  | 47nF/50\/                | Ce amic Capacitor      |                       |                            |                         |
| C201  | 1000µF/25V               | Electrolytic Capacitor |                       |                            |                         |
| C202  | 1000µF/25V               | Electrolytic Capacitor |                       |                            |                         |
| C203  | 1000μF/10V               | Electrolytic Capacitor |                       |                            |                         |
| C204  | 1000µF/10V               | Electrolytic Capacitor |                       |                            |                         |
| C205  | 47nF/50V                 | Ceramic Capacitor      |                       |                            |                         |
| C301  | 4.7nF                    | Polyester Film Cap.    |                       |                            |                         |
|       |                          |                        |                       |                            |                         |
|       | Indu                     |                        |                       |                            |                         |
| L201  | 5µH                      | Wire 1.2mm             |                       |                            |                         |
| L202  | 5µH                      | Wire 1.2mm             |                       |                            |                         |
|       |                          |                        |                       |                            |                         |
|       | Dio                      | de                     |                       |                            |                         |
| D101  | UF4007                   |                        |                       |                            |                         |

# 7. Layout

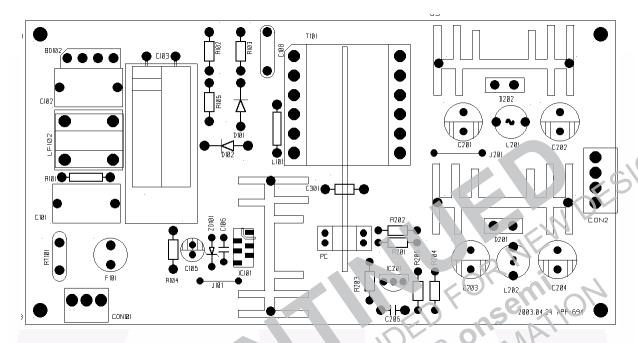


Figure 24. Layout Considerations for FSDM0565RE (Top View)

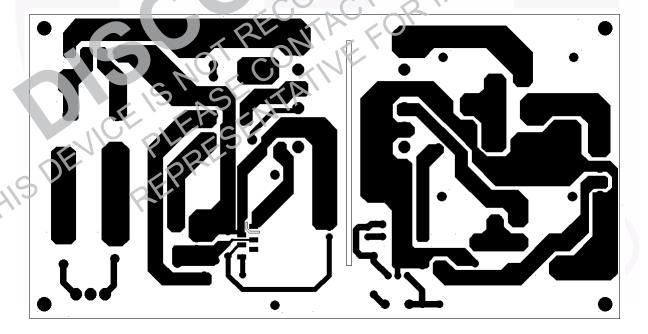
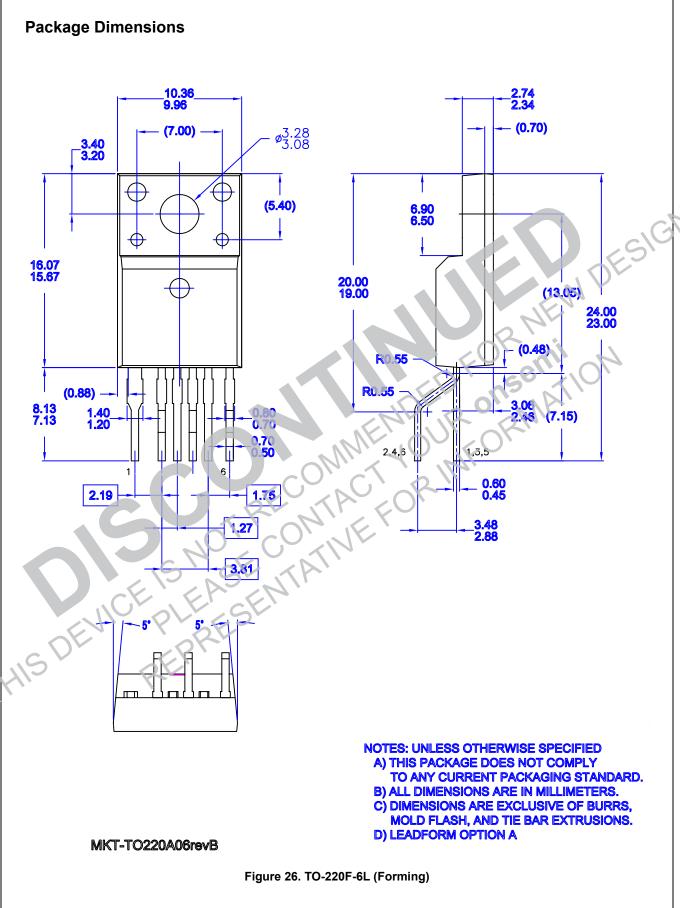


Figure 25. Layout Considerations for FSDM0565RE (Bottom View)





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